

MILITARY DATA SHEET

MN100321-X REV 0B0

Original Creation Date: 10/30/95
Last Update Date: 08/28/96
Last Major Revision Date: 10/30/95

LOW POWER 9-BIT INVERTER

General Description

The 100321 is a monolithic 9-bit inverter. The device contains nine inverting buffer gates with single input and output. All inputs have 50k ohm pull down resistors.

Industry Part Number

100321

NS Part Numbers

100321DMQB
100321FMQB

Prime Die

F321

Processing

MIL-STD-883, Method 5004

Quality Conformance Inspection

MIL-STD-883, Method 5005

Subgrp Description Temp (°C)

1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55



Features

- 30% power reduction of the 100121
- 2000V ESD protection
- Pin/function compatible with 100121
- Voltage compensated operating range= -4.2V to -5.7V
- Available to industrial grade temperature range
- Available to MIL-STD-883

(Absolute Maximum Ratings)

(Note 1)

Storage Temperature (Tstg)	-65 C to +150 C
Maximum Junction Temperature (Tj)	
Ceramic	+175 C
Plastic	+150 C
Vee Pin Potential to Ground Pin	
	-7.0V to +0.5V
Input Voltage (DC)	
	Vee to +0.5V
Output Current (DC Output HIGH)	
	-50mA
ESD	
(Note 2)	≥ 2000V

Note 1: Absolute maximum ratings are those values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: ESD testing conforms to MIL-STD-883, Method 3015.

Recommended Operating Conditions

Case Temperature (Tc)	
Commercial	0 C to +85 C
Military	-55 C to +125 C
Industrial	-40 C to +85 C
Supply Voltage (Vee)	
	-5.7V to -4.2V

Electrical Characteristics

DC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.)
DC: Vee Range: -4.2V to -5.7V, Tc= -55C to +125C, VCC=VCCA=GND

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
IIH	Input HIGH Current	Vee= -5.7V, VM= -0.87V	1, 3	INPUTS		240	uA	1, 2
			1, 3	INPUTS		340	uA	3
IIL	Input Low Current	Vee= -4.2V, VM= -1.83V	1, 3	INPUTS	0.5		uA	1, 2, 3
VOH	Output HIGH Voltage	Vee=-4.2V/-5.7V, VIH=-0.87V, VIL=-1.83V, LOADING: 50 Ohms To -2.0V	1, 3	OUTPUTS	-1025	-870	mV	1, 2
			1, 3	OUTPUTS	-1085	-870	mV	3
VOL	Output LOW Voltage	Vee=-4.2V/-5.7V, VIH=-0.87V, VIL=-1.83V, LOADING: 50 Ohms to -2.0V	1, 3	OUTPUTS	-1830	-1620	mV	1, 2
			1, 3	OUTPUTS	-1830	-1555	mV	3
VOHC	Output HIGH Voltage	Vee=-4.2V/-5.7V, VIH=-1.165V, VIL=-1.475V, LOADING: 50 Ohms to -2.0V	1, 3	OUTPUTS	-1035		mV	1, 2
			1, 3	OUTPUTS	-1085		mV	3
VOLC	Output LOW Voltage	Vee=-4.2V/-5.7V, VIH=-1.165V, VIL=-1.475V, LOADING:50 Ohms to -2.0V	1, 3	OUTPUTS		-1610	mV	1, 2
			1, 3	OUTPUTS		-1555	mV	3
VIH	Input HIGH Voltage		1, 3, 7	INPUTS	-1165	-870	mV	1, 2, 3
VIL	Input LOW Voltage		1, 3, 7	INPUTS	-1830	-1475	mV	1, 2, 3
IEE	Power Supply Current	Vee= -4.2/-5.7V	1, 3	VEE	-70	-25	mA	1, 2, 3

AC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.)
AC: Vee Range: -4.2V to -5.7V, VCC=VCCA=GND, LOADING: 50 Ohms To -2.0V

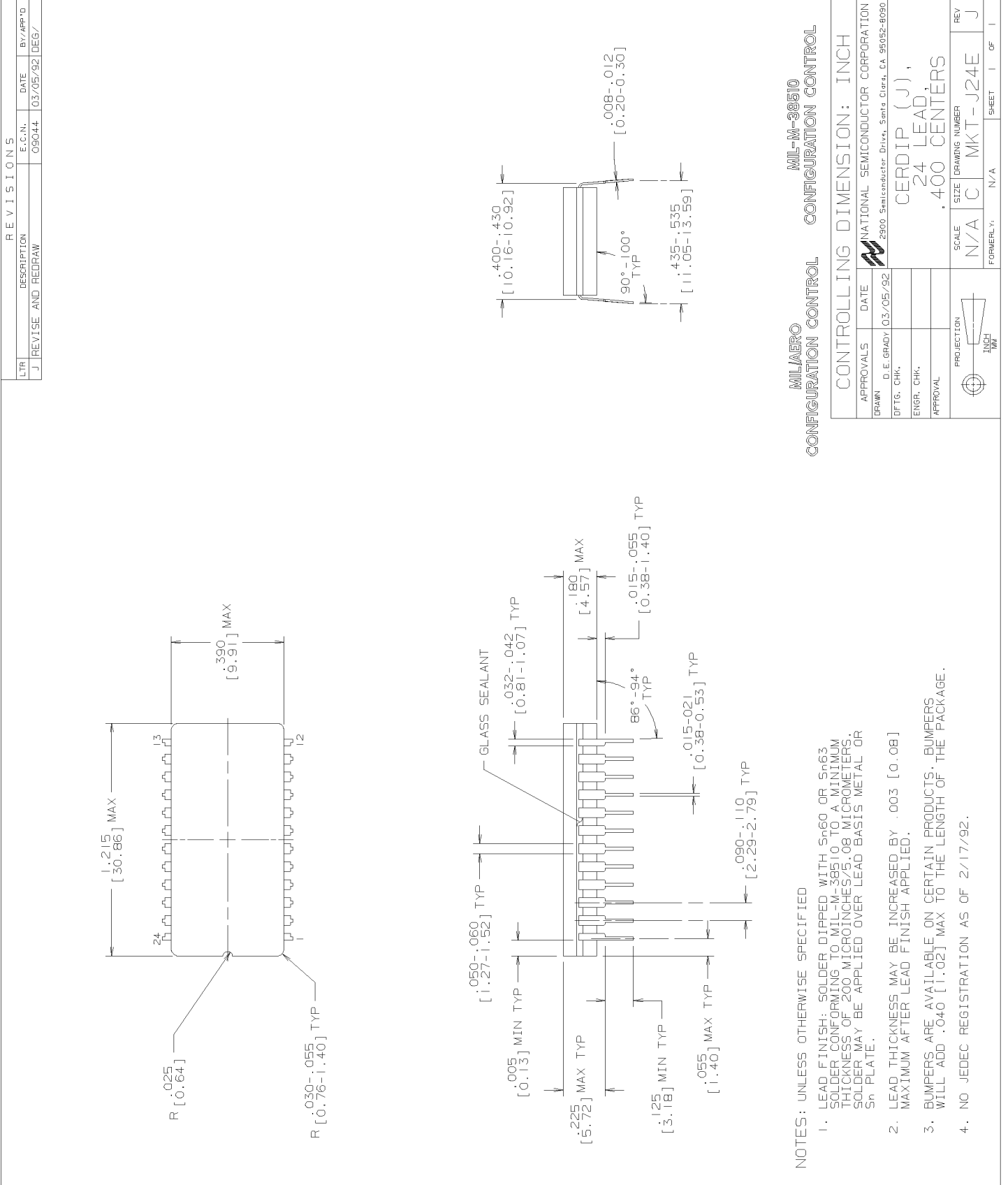
tPLH/tPHL	Propagation Delay	Vee= -4.2/-5.7V	2, 4	\overline{Dn} to \overline{On}	0.4	1.6	ns	9
			2, 4	\overline{Dn} to \overline{On}	0.4	1.8	ns	10
			2, 4	\overline{Dn} to \overline{On}	0.3	1.8	ns	11
tTLH/tTHL	Transition Time	Vee= -4.2/-5.7V	6	\overline{On}	0.3	1.2	ns	9, 10, 11

- Note 1: Screen tested 100% on each device at -55 C, +25 C and +125 C temp., subgroups 1, 2, 3, 7 & 8.
 Note 2: Screen tested 100% on each device at +25 C temp only, subgroup A9.
 Note 3: Sample tested (Method 5005, Table 1) on each MFG. lot at +25 C, +125 C & -55 C temp., subgroups A1, 2, 3, 7 & 8.
 Note 4: Sample tested (Method 5005, Table 1) on each MFG. lot at +25 C, subgroup A9, and at +125 C & -55 C temp., subgroups A10 & 11.
 Note 5: Sample tested (Method 5005, Table 1) on each MFG. lot at +25 C temp. only, subgroup A9.
 Note 6: Not tested at +25 C, +125 C & -55 C temp. (DESIGN CHARACTERIZATION DATA).
 Note 7: Guaranteed by applying specified input condition and testing VOH/VOL.

Graphics and Diagrams

GRAPHICS#	DESCRIPTION
J24ERJ	CERDIP (J), 24LD .400 CENTERS (P/P DWG)
P000046A	CERDIP (J), 24LD .400 CENTERS (PIN OUT)
P000047A	CERPAC, QUAD, 24 LEAD (PIN OUT)
W24BRE	CERPAC, QUAD, 24 LEAD (P/P DWG)

See attached graphics following this page.



MIL/AERO CONFIGURATION CONTROL		MIL-M-38510 CONFIGURATION CONTROL	
CONTROLLING DIMENSION: INCH			
APPROVALS	DATE	NATIONAL SEMICONDUCTOR CORPORATION	
DRAWN	D. E. GRADY	2900 Semiconductor Drive, Santa Clara, CA 95052-8090	
DFTG. CHK.		CERDIP (J),	
ENGR. CHK.		24 LEAD	
APPROVAL		.400 CENTERS	
PROJECTION		SCALE	SIZE DRAWING NUMBER
		N/A	C
FORMERLY:		N/A	MKT-J24E
		SHEET	1 OF 1